

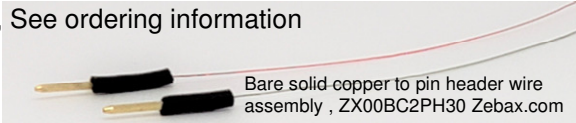
Product Name: ZX122S3MP PCISIG M.2 NGFF Socket 3 Key M passive power measurement module – Page 1 of 3

Product Description: ZX122S3MP is PCISIG M.2 power measurement module providing access to PCISIG M.2 power supply rails for purpose of characterizing , test & measurement of PCISIG M.2 supply voltages

- Measure and analyze power supply ripple, transients, Device Under Test, DUT, power consumption and more.
- a) Each power supply rail is designed with current sensing power resistor, please see block diagram.
  - b) Utilizing scope probe – test equipment , measure power supply noise, ripples, transients, and DUT power consumption.
  - c) Utilizing eLoad ( Electronic Load ) , qualify host's power supply & maximum output power.
  - d) Identify power supply trace impedance, Rdc , for improved Host / DUT PCB design.

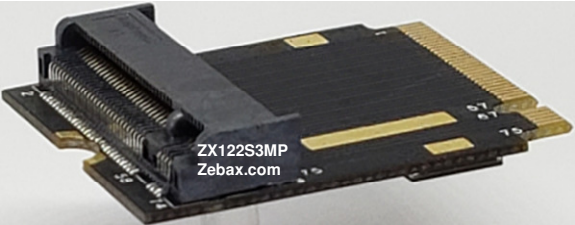
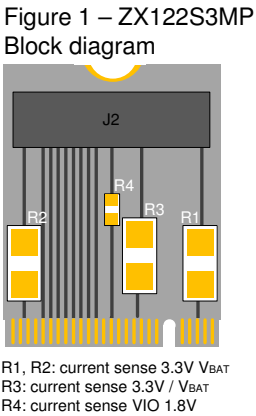
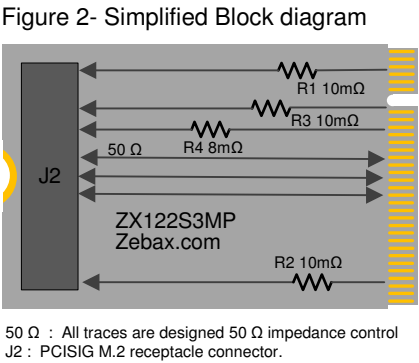
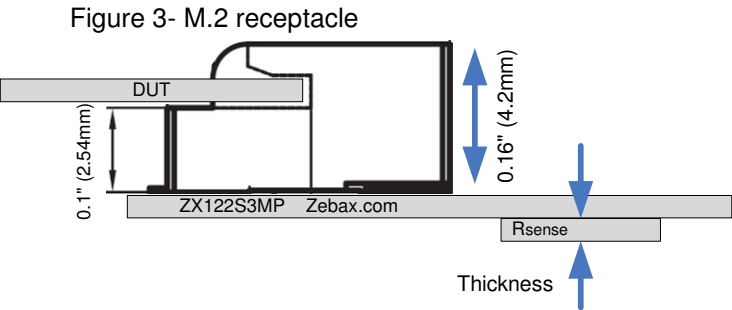
ZX122S3MP features:

- 1- Pass through PCISIG signals enabling real-time power supply test and measurement.
- 2- Onboard current sense resistors for all supply rails – Please see table 1 for details.
- 3- All other traces are pass through designed for 50 Ohms impedance controlled.
- 4- Four layers PCB design, inner layers are GND planes + Exposed copper on top and bottom fill
- 5- Accessible GND exposed copper, enabling for ease of probe access for test and measurement.
- 6- Mates with any key matching M.2 Host and Device / DUT
- 7- The module is shipped with 12pc of probing wires , ZX00BC2PH30 , See ordering information



Electrical:

Insertion loss > -2dB @6GHz  
Trace impedance: 50 Ω  
Operating Temperature: -65°C to +170°C  
M.2 Edge Connector type ( J1 ) : Key M  
Mates with: M.2 Key M  
Plating: Gold 100U  
M.2 Receptacle ( J2 ) :  
Key Type: Key M  
Height: 0.16" (4.2mm )  
Spacer : 0.1" (2.54mm) – See Figure 3  
Plating: Gold 100U  
Current per pin: 0.5A ( maximum)  
Current Sense:  
R1, R2 : 10mΩ 2512 SMD 7W - Thickness: 0.02" ( 0.5mm) Max - See Figure 3  
R3 : 10mΩ 2818 SMD 10W - Thickness: 0.059" ( 1.5mm) Max - See Figure 3  
R4 : 8mΩ 0805 SMD 1W  
Ratings: AEC-Q200  
Temperature Coefficient: ±75ppm / °C  
Operating Temperature: -65°C to +85°C at 100% listed power rating, see Table 1  
-65°C to +170°C see section Power Rating on page 3  
Shunt:  
Package: 0402 SMD



Current Sense resistors: Table 1 lists onboard ZX122S3MP current sense resistors and associated PCISIG M.2 connector assignment

Table 1

Current Sense Resistor	PCISIG M.2 Connector pin number	PCISIG M.2 Supply Rail	Description	Package	
				(inch)	(mm)
R1	2, 4,	3.3 V	10m Ohms 1% 7W	2512	6432
R2	70, 72, 74	3.3 V	10m Ohms 1% 7W	2512	6432
R3	12, 14, 16, 18	3.3 V	10m Ohms 1% 10W	2818	7146
R4	22	1.8 V	8m Ohms 1% 1W	805	2012

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Compliance:

ISO2001 certified  
RoHs - Lead Free  
EU RoHS2  
UL E111594 document  
ELV- Vehicle Directive ( Directive 2000/EC)  
European Union Directive ( 203/11/EC )  
Halogen Free per IEC-61249-2.21 : 2003  
RoHs Directive 2011/65/EU  
WEEE Directive ( 2012/12/EU)

Certificate of Compliance for Radioactive substances  
Certificate of Compliance for Asbestos  
Certificate of Compliance for Ozone Depleting Substances, ODS  
Certificate REACH SVHC  
Certificate of Compliance RoHS\_EN\_CoC

ZX122S3MP package includes:

Part number	PCB Edge	J2	Quantity	Description
ZX122S3MP	Key M	Key M	1	M.2 PCISIG Socket 3 power measurement module
ZX00BC2PH30			12	30AWG Bare Copper wire to pin header wire assembly

[ZX00BC2PH30 site page](#) for ordering ZX00BC2PH30 wire assembly

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SPECIFIED DIMENSIONS ARE INCHES (MM). ROHS COMPLIANT		ASSEMBLY DRAWING
		ITEM: ZX122S3MP
DESCRIPTION: PCISIG M.2 NGFF Socket 3 Key M passive power measurement module		
CHECKED:	DRAWN:	REVISION: 1.0
M. MARINA	MATTHEW CT	
		SHEET: 1 OF 3

**Current Sense resistors:** The current sense resistors may be removed if external electronic load , eLoad, is used. eLoad test equipment may be applied to ZX122S3MP for power supply characterization , test and measurements. Eload suppliers : BK Precision , Chroma, Instek , Kikusui and more

**Signal assignments:** Table 2 exhibits the routed M.2 PCISIG signals on the ZX122S3MP module.  
**Please note:** Table 2 represents only the PCISIG M.2 Socket 3 Key M power supply and the assigned GND , PCISIG M.2 reference ground, signal assignments for “Socket 3 Key M” applications.

**Ground / Exposed Copper :**  
All of the PCISIG M.2 GND , reference ground , signals are connected to each other along with the 2 inner GND planes. In addition; the exposed copper on the ZX122S3MP is the module’s GND for purpose of rework and probing purpose.

PCISIG M.2 signals :  
ZX122S3MP passes through all PCISIG M.2 signals ( excluding the power supply rails . All traces are 50 Ohms impedance controlled. ZX122S3MP passes through limited number of NC, No Connect , signals. Please see NC, No Connect section below for more details.

NC, No Connect :  
Due to space constraints, ZX122S3MP does not pass through all the **NC** PCISIG M.2 signals. By definition, these signals are Not Connect, therefore they could be left open ended. The NC signals which ZX122S3MP does not support have open connection at both J1 and J2 connectors. All the listed signals marked **Note 3** in table 2 have not been routed from J1 to J2. The listed signals are open at J1 and J2 connectors.

**Application:** Bringup, testing, emulation, development, modular design evaluations  
M.2 PCISIG Socket power supply test characterization  
SDIO SSD SATA WWAN DP WIFI GPS GYRO Compass BT FM sensor module  
Socket 3 Add-in Card Key M, Socket 3 DisplayPort Key M , Socket 3 SDIO Key M  
Socket 2 WWAN Key M , Socket 2 PCIe-based SSD Key M , Socket 2 SATA-based SSD Key M  
Socket 2 PCIe / USB 3.1 Gen1-Based WWAN Key M , Socket2 PCIe-Based WWAN Key M  
Socket 2 USB3.1 Gen1-based WWAN Key M , Socket 2 SSIC WWAN Key M  
Socket 3 PCIe-based Key M , Socket 3 SATA-based Key M

**Mates with :** Any standard M.2 NGFF PCISIG connector on host and device Key M  
TE 2199125 2199119 2199230 2199133 JAE SM3ZS067  
Bellwether: SD-80148 SD-80149 SD-80152 SD-80159 Amphenol

**Module Insertion, Removal process:**  
In order to avoid any mechanical stress or damage to ZX122S3MP, please follow the below listed guidelines for insertion and removal process:

1- Move the Module against the housing chamber, see figure 1  
2- Rotate module to 25°, insert it until the module surface reaches the ramp, figure 2, 3  
3- Rotate the module to horizontal position, see figure 4  
4- Fix the module by screw, see figure 5

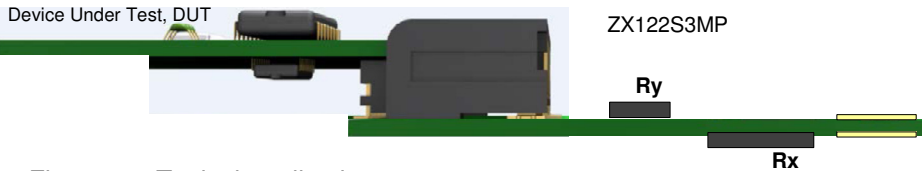
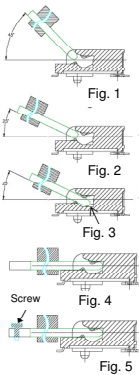


Figure 4 – Typical application - Rx, Ry : Current sense resistors

Table 2 – PCISIG M.2 Socket 3 Key M  
**Please note:** Table 2 represents only the PCISIG M.2 Socket 3 Key M power supply and the assigned GND , PCISIG M.2 reference ground, signal assignments for

Socket 3 Key M						
Signal	PCISIG M.2 connector pin				Pin	Signal
	Pin	ZX122S3MP		Pin		
		Label <sup>1</sup>	Label <sup>1</sup>			
3.3 V	74	R2		EP <sup>2</sup>	75	GND
3.3 V	72			71	GND	
3.3 V	70			ADD_IN CARD KEY M	65	ADD_IN CARD KEY M
ADD_IN CARD KEY M	66	63				
	64	61				
	62	59				
	60	EP <sup>2</sup>	57	GND		
NC	48		Note 3	51	GND	
NC	46		Note 3	45	GND	
GND	38		EP <sup>2</sup>	39	GND	
GND	32			33	GND	
VIO 1.8 V	22		R4	27	GND	
NC	28		Note 3	21	GND	
NC	26		Note 3	15	GND	
NC	24		Note 3	9	GND	
NC	20		Note 3	3	GND	
3.3 V	18		R3	1	GND	
3.3 V	16					
3.3 V	14					
3.3 V	12					
		R1				
3.3 V	4					
3.3 V	2					

Note 1: Label is the listed reference designator for the current sense resistors  
2- Exposed Copper is connected to inner GND planes, see Exposed Copper  
3- The listed NC, No Connect, assigned signals for PCISIG M.2 Socket 3 Key M - are not connected between J1 and J2 connectors, therefore they listed pin in open at J1 and J2 connectors.

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ASSEMBLY DRAWING

ITEM: ZX122S3MP

DESCRIPTION: PCISIG M.2 NGFF Socket 3 Key M passive power measurement module

CHECKED: M. MARINA

DRAWN: MATTHEW CT

REVISION: 1.0

SHEET: 2 OF 3

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Product Name: ZX122S3MP PCISIG M.2 NGFF Socket 3 Key M passive power measurement module – Page 3 of 3

Typical Application: ZX122S3MP is designed for purpose of PCISIG M.2 power supply characterization, test and debug at full connector’s bandwidth. It provides onboard current sense resistors where scope probe could be utilized for measuring characterization data for qualifying the host or device functional behavior. Additionally, the current sense resistors may be replaced by eLoad for transient and dynamic load throttling. Below are few suggestions in respect to proper power supply measurements using ZX122S3MP module:

Scope Probe wire Installation:

Utilize the supplied ZX00BC2PH30 bare copper to pin wire assembly whenever possible – Based on availability of type of scope + probing options, install probe wire as listed below

- 1- It is recommended to keep the +probe wire length at 0.5" ( 1.2cm ) long.
- 2- In order to avoid ground loop problems, please use the shortest Ground probe wire interfacing to the nearest GND reference. ZX122S3MP provides several exposed copper test points for probing purpose.
- 3- Ensure scope probe’s bandwidth is set at 20MHz – Certain tests require full scope + scope probe bandwidth; however , industry standard is 20MHz bandwidth for power supply test and measurements.
- 3- Both Keysight as well as Tektronix offer variety of single ended as well as differential probes along with their accessories, below are few probes from each vendor:

- a) Keysight differential probe or similar N2795A, N2796A, 1168V, 1134B along with E2677B differential Solder-in probe, N5426A ZIF Tip, N2884A Fine Wire ZIF Tip and more – See the figure “probe head accessories”.
- b) Tektronix offers several single-ended as well as differential probes such as : P6243, P6245, P6248, P6246, P6247 or any TP1500, TAP2500, TAP3500, TAP4000, P7240 of TDP7000 series or equivalent

- 4- Please follow your vendor’s guideline in installation of probe wires & accessories.

Power Rating :Onboard current sense resistors on ZX122S3MP module are designed for maximum power consumption per PCISIG M.2 specification operating within -65 °C to 70 °C temperature range. The current sense resistor’s power rating will degrade at above 85 °C test environment. It is highly recommended to utilize external cooling fan if your design expects to exceed maximum current via each PCISIG M.2 pin ( 0.5A per pin ) at above 85 °C test environment.

The onboard current sense resistors operate at 100% listed power ratings ( see Table 1 ) within temperature range :

- R1, R2 : -65 °C ≤ operating temperatures ≤ 85 °C with tolerance = ±1%
- R3, R4 : -65 °C ≤ operating temperatures ≤ 70 °C with tolerance = ±1%

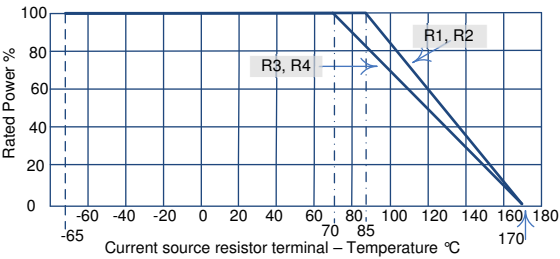
The onboard current sense resistors power ratings derail at above 70 °C. Figure 4 exhibits the current sense resistors derating curve.

Current sense resistors rated power ;  $P = VI = I^2 \times R$  where I is the maximum current for the listed resistor value R

Below are few suggestions, if your test & measurement environment falls ≥ +70 °C temperature range :

- 1- Apply cooling fan where the current sense resistor’s terminal blocks are measured at 70 °C – Please note - The ZX122S3MP module design provides heatsink solution to the onboard current sense resistors via inner layers thermal distribution method.
- 2- Replace the onboard current sense resistors with lower values ( similar footprint ), resulting at higher power ratings at ≥ 70 °C test environment.
- 3- Replace onboard current sense resistors with eLoad ( electronic Load Board / System ) – eLoad system resides outside of test chamber, therefore it is not subject to temperature degradation.

Figure 4 – Current sense resistor Derating chart

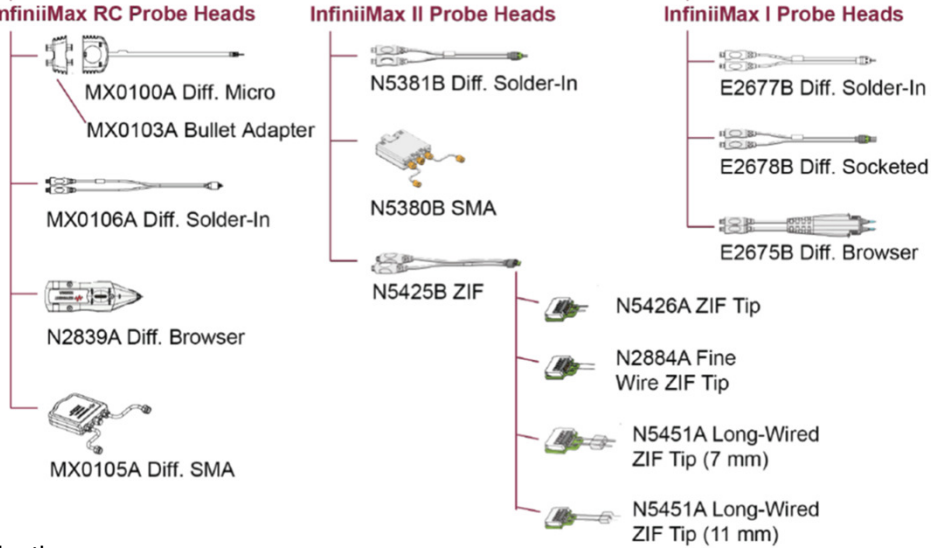


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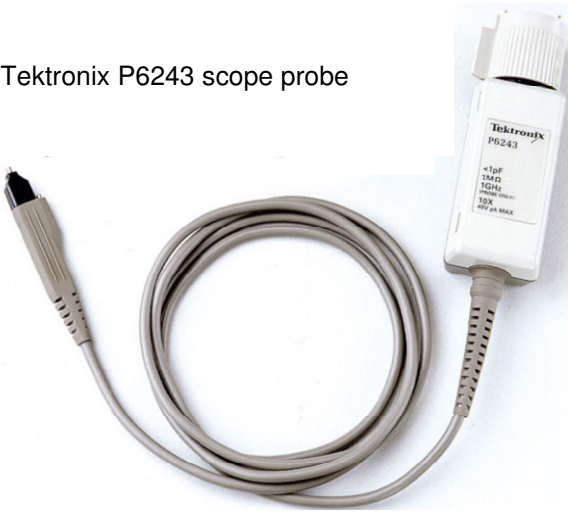
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Keysight Probe Head accessories



Tektronix P6243 scope probe



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